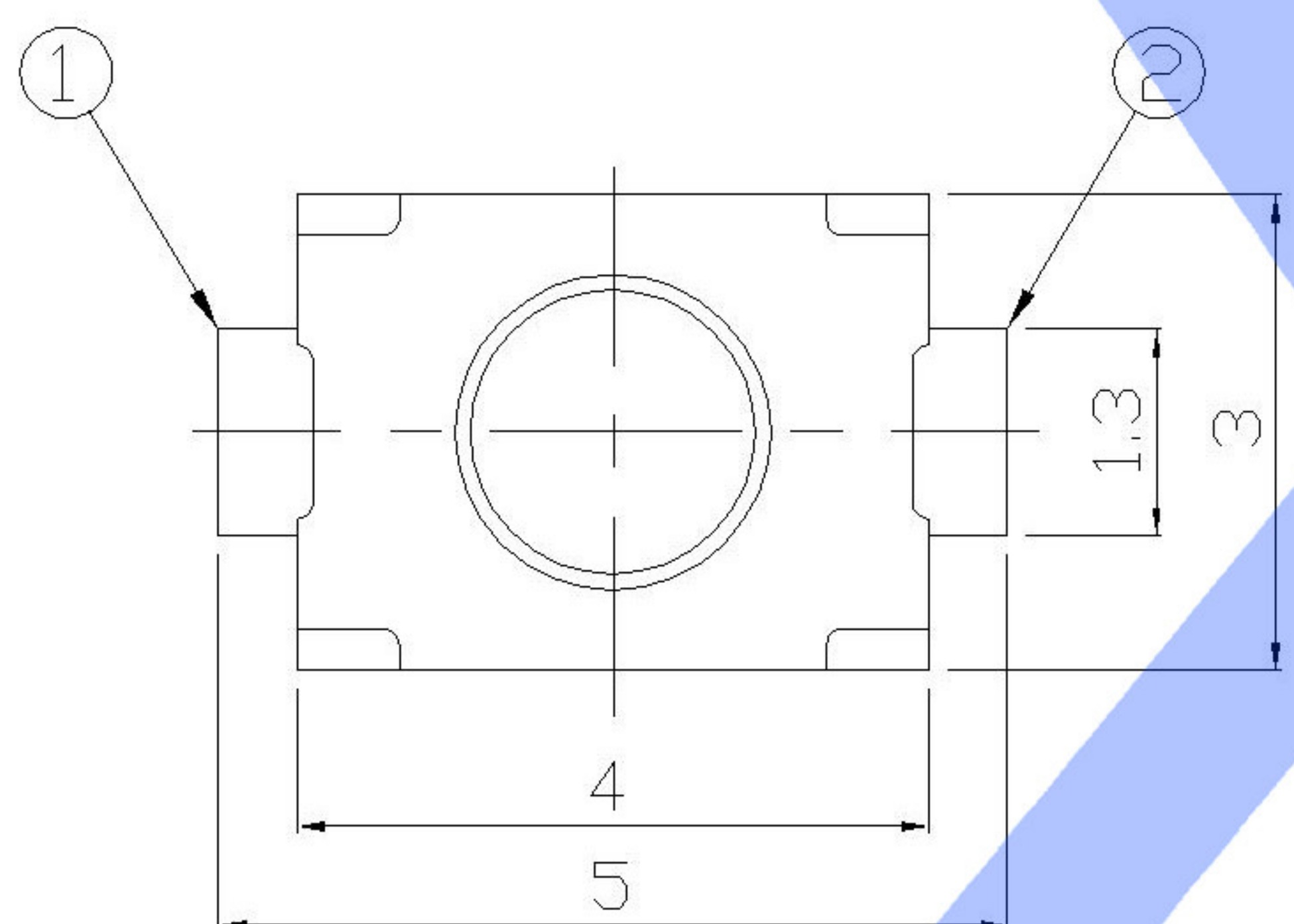
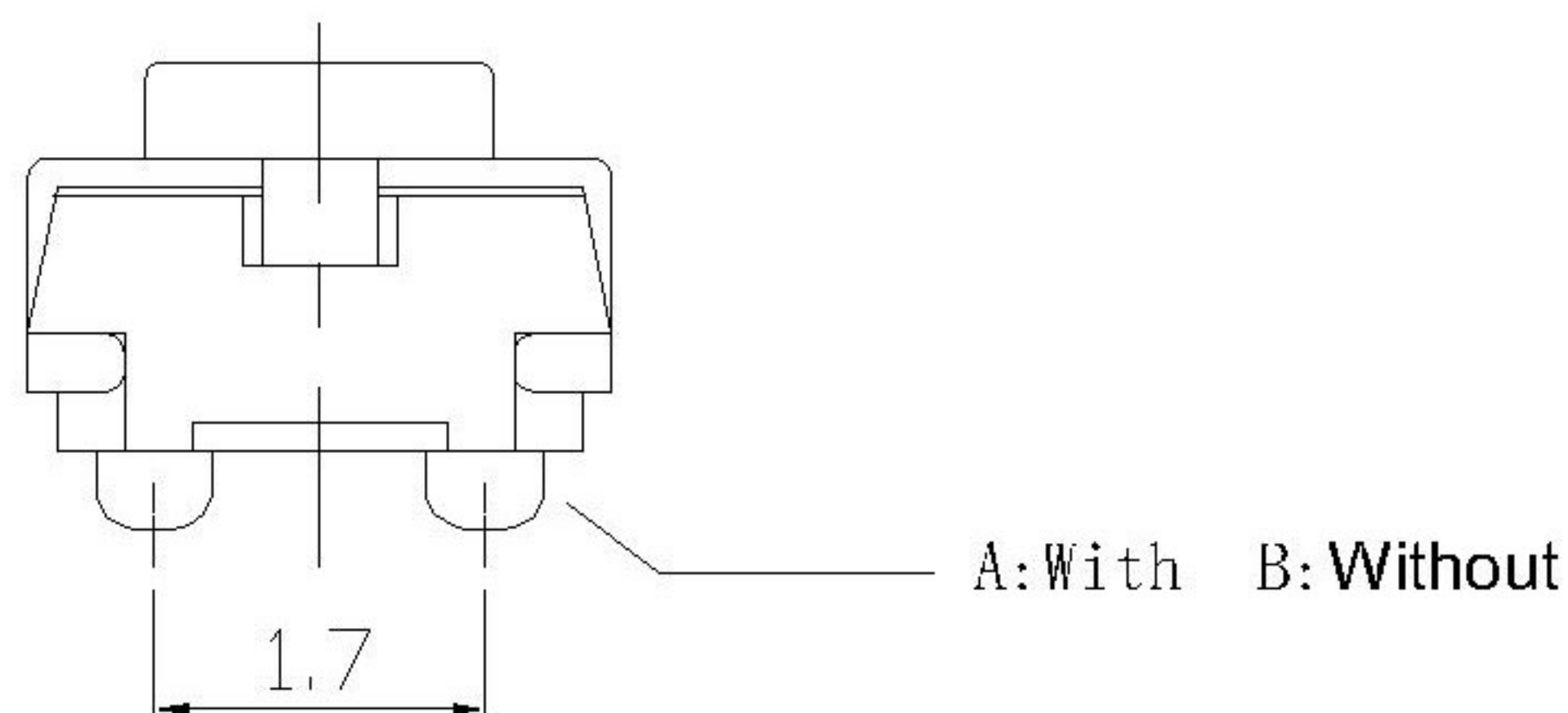
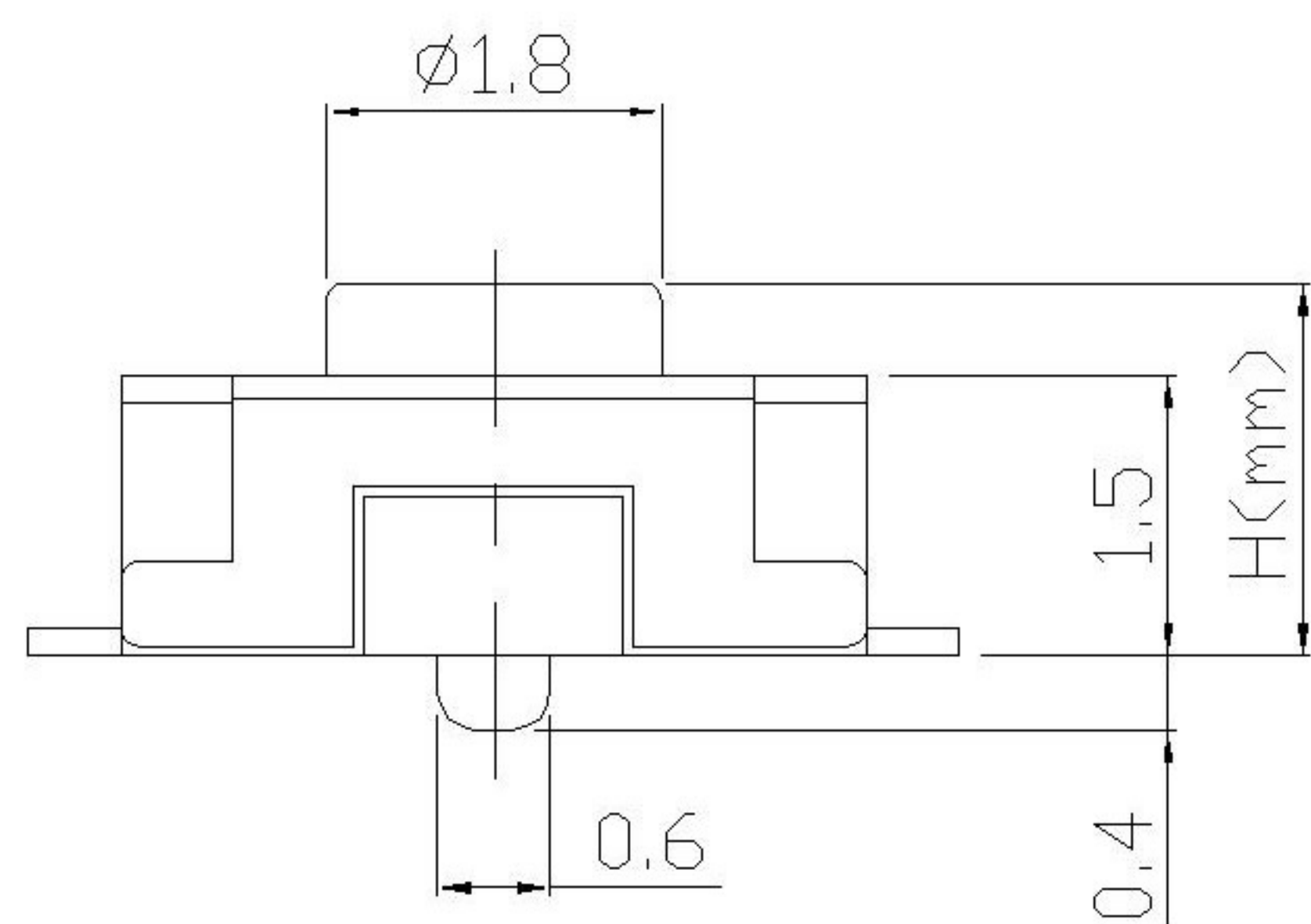
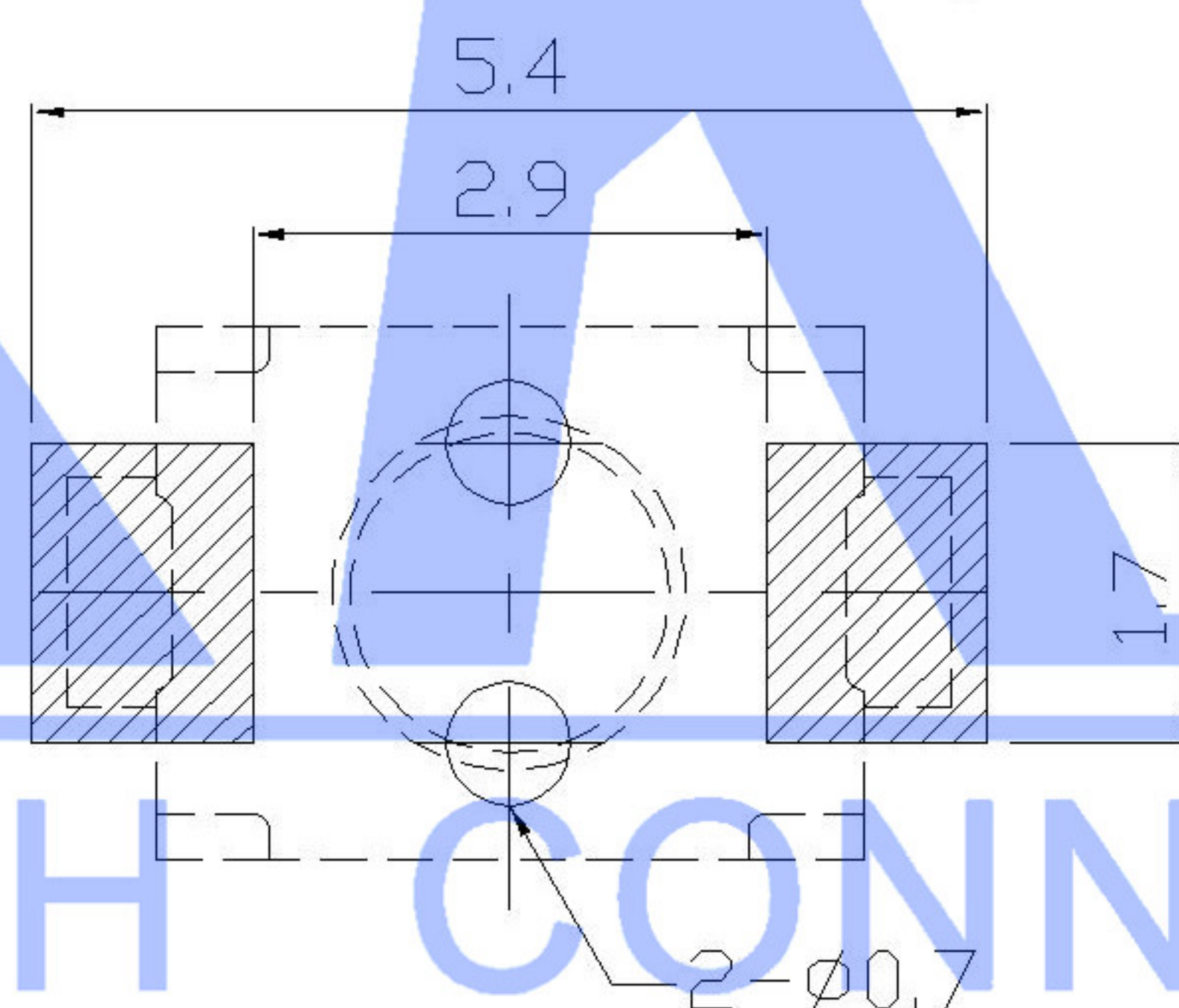




P.C.B. MOUNTING PATTERN DIMENSION
The following soldering patterns are recommended for reflow soldering

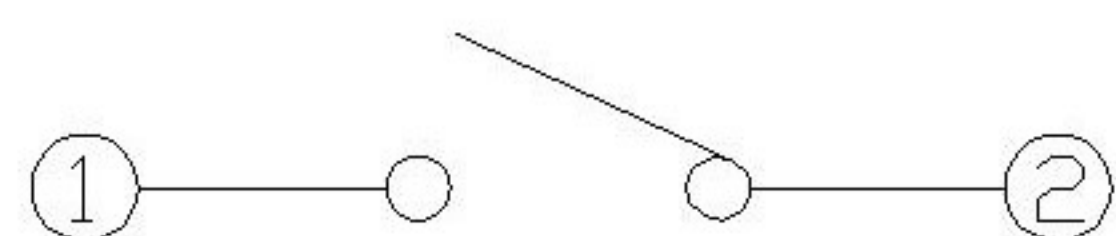


SPECIFICATION

Contact Rating: 50mA,12V DC
Contact Resistance: 100mΩ max
Insulation Resistance: 100mΩ min.500V DC
Dielectric Strength: 250V AC/1minute
Travel: 0.13mm
Operating Temp: -30℃~+85℃
Storage Temp: -30℃~+80℃

PAPT NO	TS-1185-X-X-X-A
Operating Force	A:100gf B:160gf C:260gf
Height	H:A:2.0 B:2.5
Fixed column	A:With B:Without
Keystake	A:PA46 B:Silica gel

CIRCUIT DIAGRAM



⑤	Terminal	—	2	Brass (0.30t)	Plating silvering	—
④	Contact	—	1	F.ag/Sus	Natural	—
③	Base	—	1	Lcp		—
②	Cover	—	1	Brass	Plating Nickel	—
①	Keystake	—	1	Lcp		—
ITEM	PAPT NAMF	TER,NO	QTY	MATERIAL	FINISHING	REMARK

						DSND		DATE		SCALE: N/A	MODEL TYPE:
						DWN		DATE		VIEW:	TACT SWITCH
						CHKD		DATE		UNIT: mm	PART NO.:
						APPD		DATE		SIZE: A4	DWG NO.:
										TS-1185-X-X-X-A	
										WEIGHT	SHEET
										1.0g	1/1
										REVISION	
										A0	